

**Absolute Maximum Ratings** (Voltage relative to GND, @ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Supply Voltage	$V_{IN}$	-0.3 to 100	V
Continuous Input & Output Current	$I_{IN}, I_{OUT}$	750	mA
Peak Pulsed Input & Output Current	$I_{IM}, I_{OM}$	2	A
Maximum Voltage applied to $V_{OUT}$	$V_{OUT(max)}$	Smaller of $V_{IN}+12\text{V}$ or 18V	V

**Maximum Current at  $V_{IN} = 48\text{V}$**  (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Continuous Output Current	$I_{OUT}$	60	mA
Pulsed Output Current	$I_{OM}$	960	mA
		200	

**Thermal Characteristics**

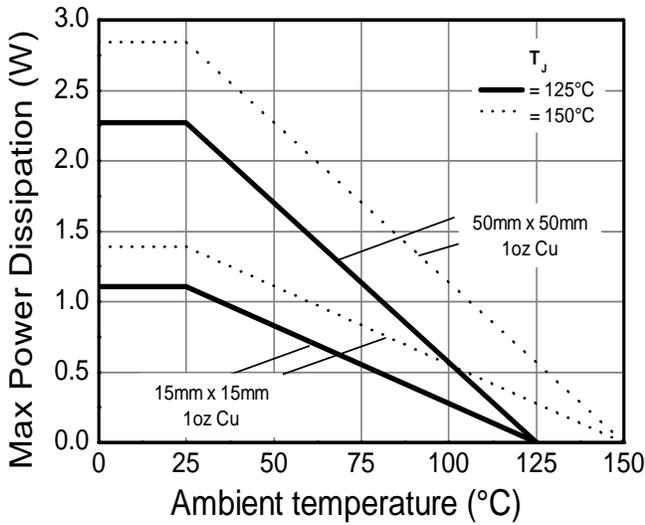
Characteristic	Symbol	Value	Unit
Power Dissipation	$P_D$	2.3	W
		1.1	
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	44	$^\circ\text{C/W}$
		90	
Thermal Resistance, Junction to Lead	$R_{\theta JL}$	8.4	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	14.6	
Recommended Operating Junction Temperature Range	$T_J$	-40 to +125	$^\circ\text{C}$
Maximum Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	

**ESD Ratings** (Note 11)

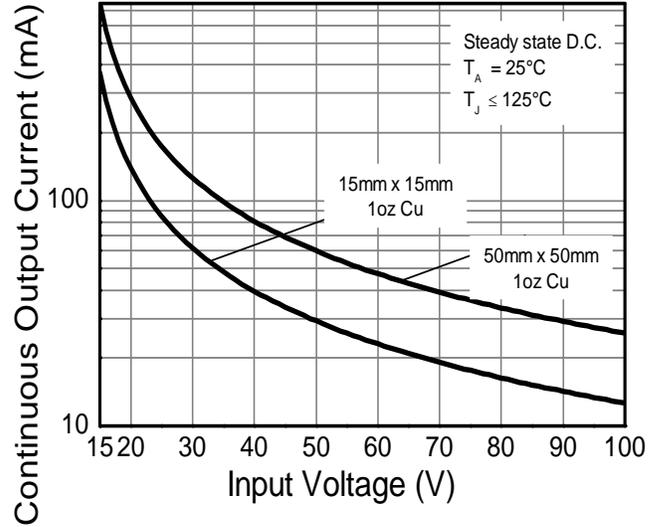
Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the exposed  $V_{IN}$  pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  - Same as note 5, except mounted on 15mm x 15mm 1oz copper.
  - Same as note 5, whilst operating at  $V_{IN} = 48\text{V}$ . Refer to Safe Operating Area for other Input Voltages.
  - Same as note 5, except measured with a single pulse width = 100 $\mu\text{s}$  and  $V_{IN} = 48\text{V}$ .
  - Same as note 5, except measured with a single pulse width = 10ms and  $V_{IN} = 48\text{V}$ .
  - $R_{\theta JL}$  = Thermal resistance from junction to solder-point (on the exposed  $V_{IN}$  pad).
  - $R_{\theta JC}$  = Thermal resistance from junction to the top of case.
  - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

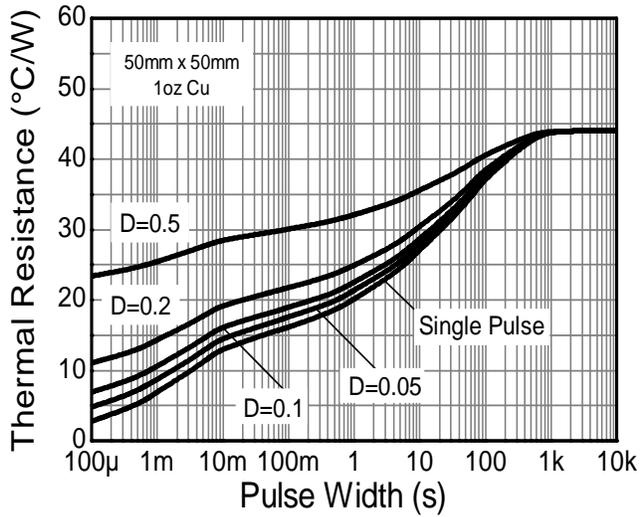
**Thermal Characteristics and Derating Information**



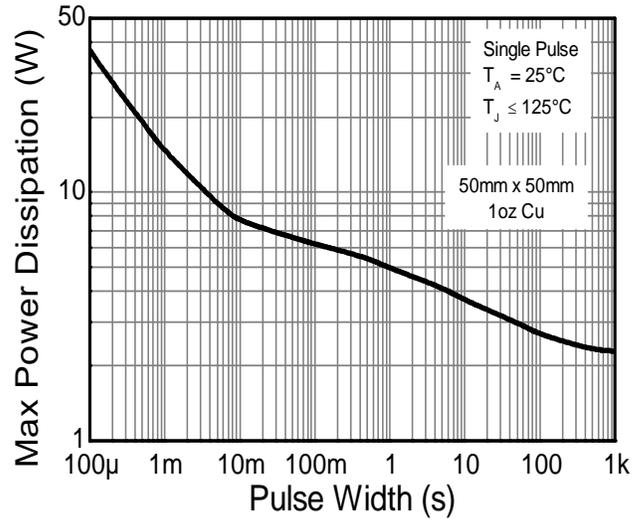
**Derating Curve**



**Safe Operating Area**



**Transient Thermal Impedance**



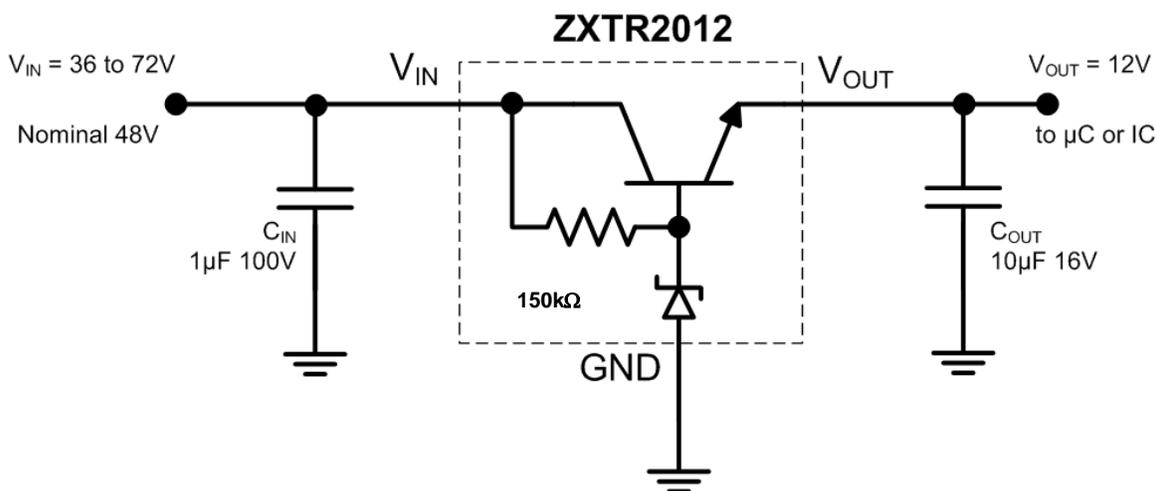
**Pulse Power Dissipation**

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V <sub>OUT</sub>	10.8	12	13.2	V	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Line Regulation (Notes 12 & 13)	ΔV <sub>OUT</sub>	—	240	750	mV	V <sub>IN</sub> = 15 to 72V, I <sub>OUT</sub> = 15mA
Temperature Coefficient	ΔV <sub>OUT</sub> /ΔT	—	8.0	—	mV/°C	T <sub>J</sub> = -40°C to +125°C V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Load Regulation (Notes 12 & 14)	ΔV <sub>OUT</sub>	—	-450 -600	-600 -750	mV	I <sub>OUT</sub> = 0.1 to 30mA, V <sub>IN</sub> = 48V I <sub>OUT</sub> = 0.1 to 100mA, V <sub>IN</sub> = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V <sub>IN(MIN)</sub>	15	—	—	V	—
Quiescent Current	I <sub>Q</sub>	—	240 590	400 900	μA	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 10μA V <sub>IN</sub> = 100V, I <sub>OUT</sub> = 10μA
Power Supply Rejection Ratio	ΔV <sub>IN</sub> /ΔV <sub>OUT</sub>	—	45	—	dB	C <sub>OUT</sub> = 100nF, I <sub>OUT</sub> = 15mA, V <sub>OUT</sub> = 12V, V <sub>IN</sub> = 15 to 100V, f = 100Hz

Notes:

12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%
13. Line regulation  $\Delta V_{OUT} = V_{OUT}(@ V_{IN} = 72V) - V_{OUT}(@ V_{IN} = 15V)$
14. Load regulation  $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 30mA) - V_{OUT}(@ I_{OUT} = 0.1mA)$   
 $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 100mA) - V_{OUT}(@ I_{OUT} = 0.1mA)$

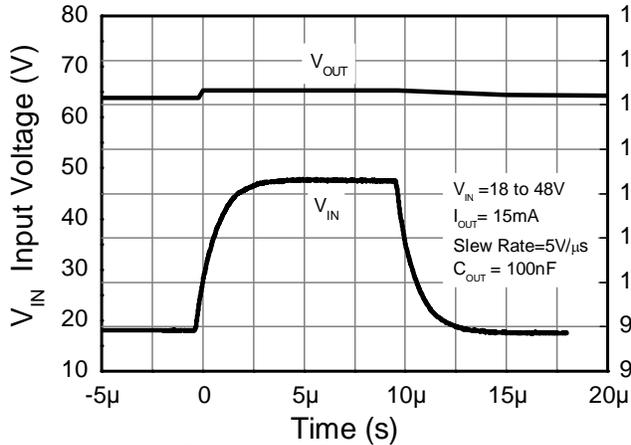
**Typical Application Circuit**


Example of an 12V regulated supply from a nominal 48V for powering a Controller IC.

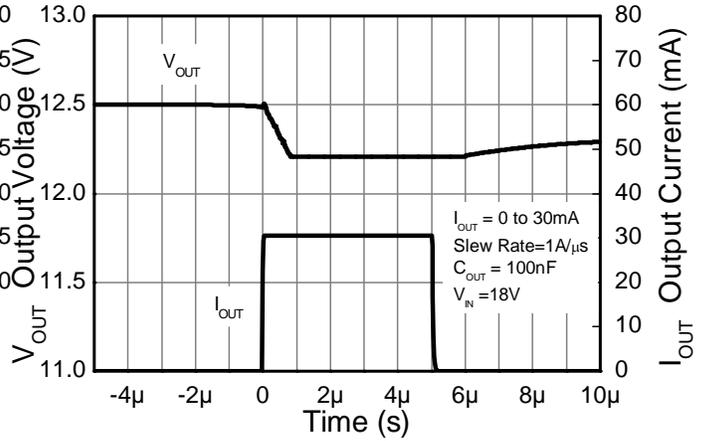
**Pin Functions**

Pin Name	Pin Function	Notes
V <sub>IN</sub>	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V <sub>OUT</sub> regulated then 15V ≤ V <sub>IN</sub> ≤ 100V. It is recommended to connect a 1μF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V <sub>OUT</sub>	Voltage Output	Outputs a regulated 12V when 15V ≤ V <sub>IN</sub> ≤ 100V. When V <sub>IN</sub> < 15V, then V <sub>OUT</sub> maximum = V <sub>IN</sub> - 1.5V. The pin can be pulled high to a maximum of +18V with respect to GND, or +12V with respect to V <sub>IN</sub> , whichever is lower. It is recommended to connect a 10μF capacitor to GND and a minimum of 10μA to be drawn from V <sub>OUT</sub> to maintain regulation.

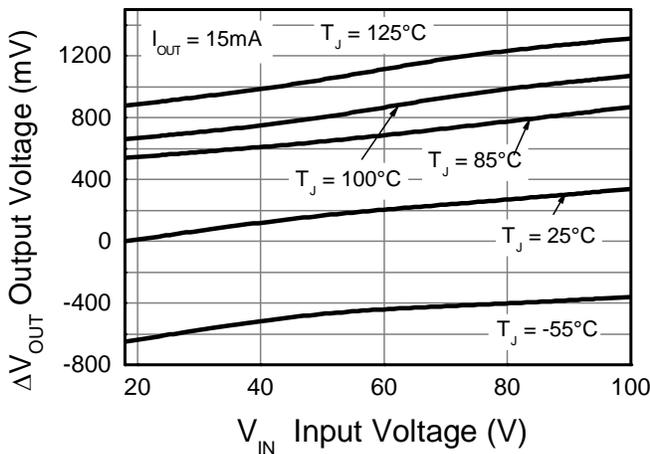
**Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



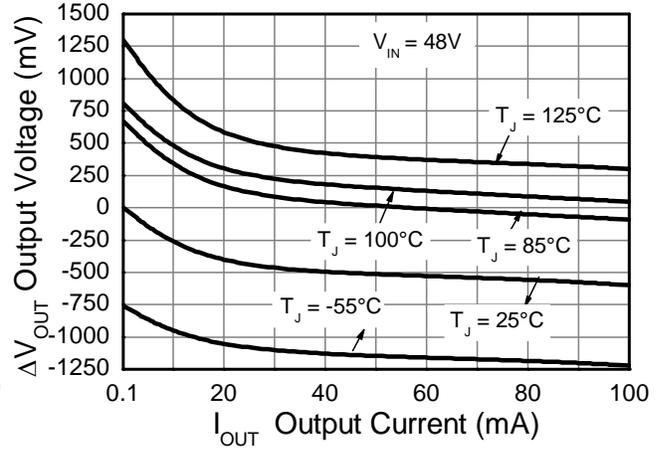
**Line transient response**



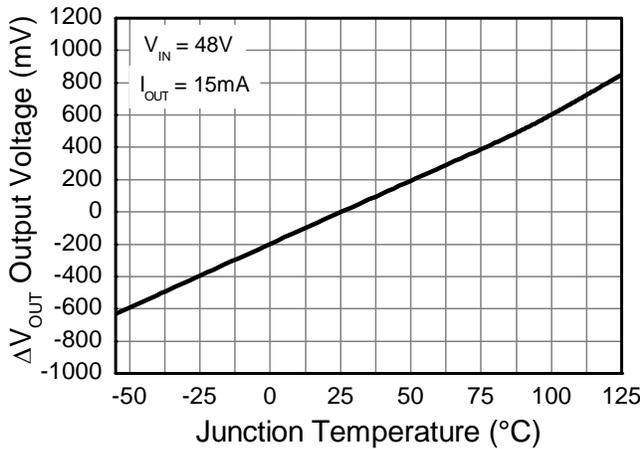
**Load transient response**



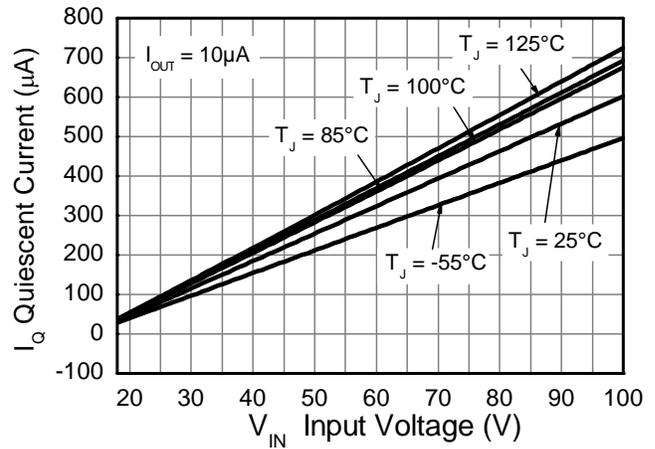
**Line Regulation (Note 15)**



**Load Regulation (Note 16)**



**Temperature Coefficient (Note 17)**

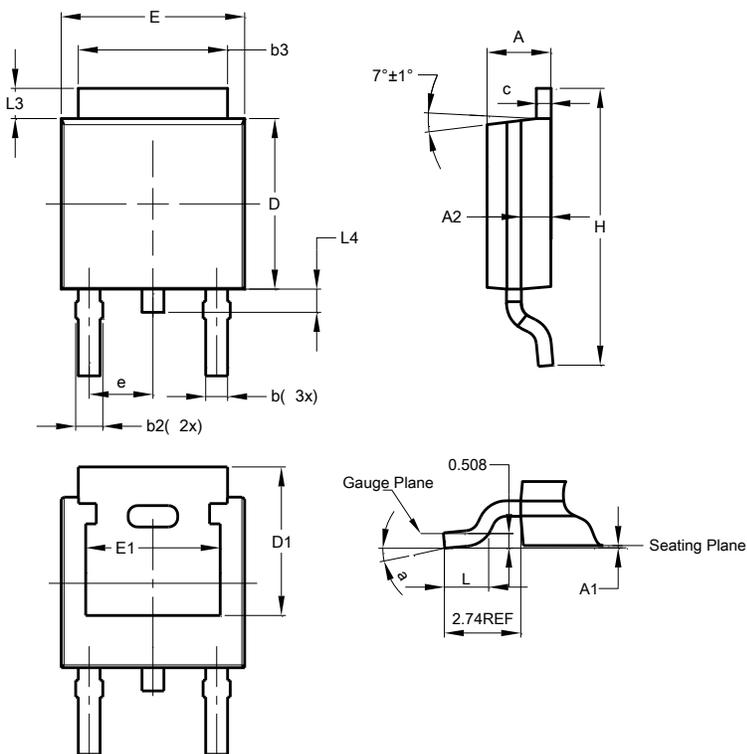


**Quiescent Current**

- Notes:
- 15. Line regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 15V, I_{OUT} = 15mA, T_J = +25^\circ C)$
  - 16. Load regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 48V, I_{OUT} = 0.1mA, T_J = +25^\circ C)$
  - 17. Temperature Coefficient  $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 48V, I_{OUT} = 15mA, T_J = +25^\circ C)$

### Package Outline Dimensions

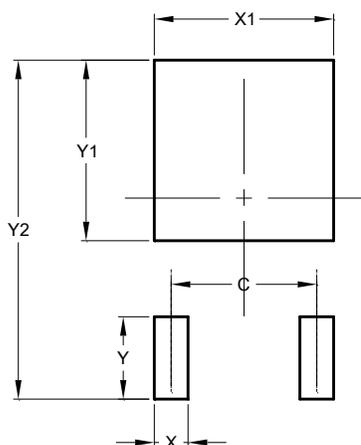
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	-
<b>All Dimensions in mm</b>			

### Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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